

17. (New) A chip part device as claimed in claim 16, wherein said groove is formed extending in a direction traversing an ultrasonically vibrating direction of the ultrasonic bonding.

18. (New) A chip part device as claimed in claim 16, wherein said at least two grooves is provided in said conductive layer as at least one of an isolated notch part and a recess located proximate to and not extending within said one of said bonding areas, wherein said notch part or recess partially narrows said conductive pattern to form a narrow pattern part.

#### REMARKS

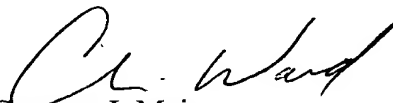
Favorable reconsideration of this application as presently amended is respectfully requested.

Claims 16-18 are presently active in this case, Claims 7, 9, and 13-15 having been canceled and Claims 16-18 having been added by way of the present amendment.

It is respectfully submitted that the present application is in condition for formal allowance and an early and favorable reconsideration of this application is therefore requested.

Respectfully submitted,

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